

EKC652™

A SAC™ (Advanced Semi Aqueous Chemistry)

Product Description

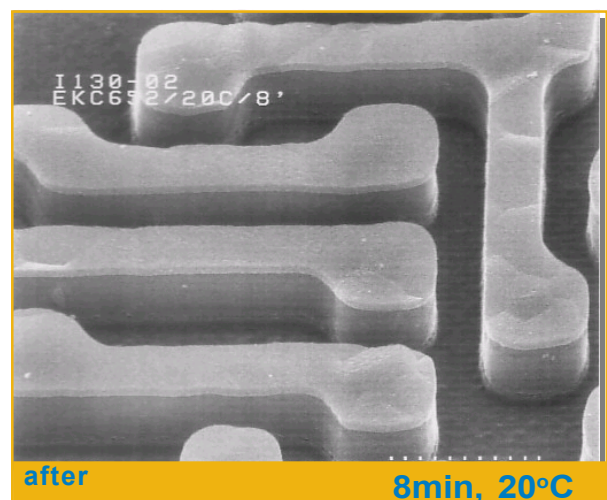
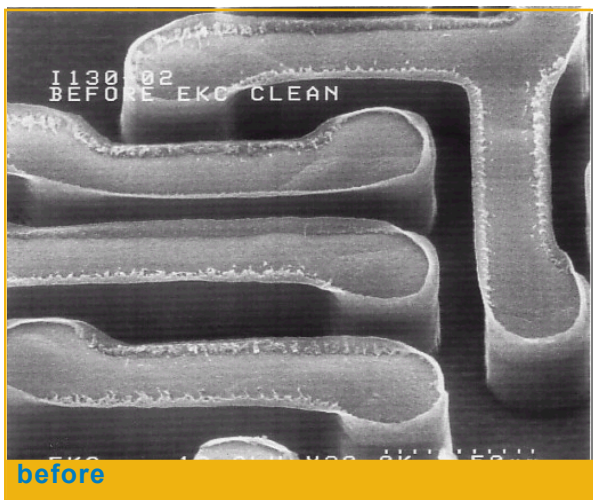
EKC652™ is a semi-aqueous formulation that removes post-etch residue quickly and effectively from substrates containing traditional integration materials.

Applications

EKC652™ is specifically designed to remove PER from traditional integration materials in either wet bench or batch spray operation. Enables high yield production of 250nm semiconductor devices.

Product Performance

- Ideally suited for devices with critical dimensions 250nm
- Compatible with a variety of traditional integration materials
- Good bath life and low CoO
- Operates well in a variety of equipment, wet bench or batch spray
- Enables processing through improved device electrical performance
- Smaller environmental footprint solution



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